

Data Sheet July 1999 File Number 4616.1

Radiation Hardened Octal Buffer/Line Driver, Three-State

Intersil's Satellite Applications FlowTM (SAF) devices are fully tested and guaranteed to 100kRAD total dose. These QML Class T devices are processed to a standard flow intended to meet the cost and shorter lead-time needs of large volume satellite manufacturers, while maintaining a high level of reliability.

The Intersil HCS244T is a Radiation Hardened Non-Inverting Octal Buffer/Line Driver, Three-State, with two active-low output enables.

Specifications

Specifications for Rad Hard QML devices are controlled by the Defense Supply Center in Columbus (DSCC). The SMD numbers listed below must be used when ordering.

Detailed Electrical Specifications for the HCS244T are contained in SMD 5962-95731. A "hot-link" is provided from our website for downloading.

www.intersil.com/spacedefense/newsafclasst.asp

Intersil's Quality Management Plan (QM Plan), listing all Class T screening operations, is also available on our website.

www.intersil.com/quality/manuals.asp

Ordering Information

ORDERING INFORMATION	PART NUMBER	TEMP. RANGE (°C)
5962R9573101TRC	HCS244DTR	-55 to 125
5962R9573101TXC	HCS244KTR	-55 to 125

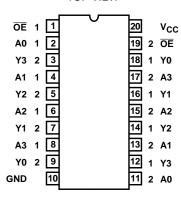
NOTE: Minimum order quantity for -T is 150 units through distribution, or 450 units direct.

Features

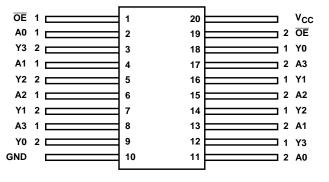
- QML Class T, Per MIL-PRF-38535
- · Radiation Performance
 - Gamma Dose (γ) 1 x 10⁵ RAD(Si)
 - Latch-Up Free Under Any Conditions
 - SEP Effective LET No Upsets: >100 MEV-cm²/mg
 - Single Event Upset (SEU) Immunity < 2 x 10⁻⁹ Errors/Bit-Day (Typ)
- 3 Micron Radiation Hardened CMOS SOS
- Fanout (Over Temperature Range)
- Bus Driver Outputs 15 LSTTL Loads
- Significant Power Reduction Compared to LSTTL ICs
- DC Operating Voltage Range: 4.5V to 5.5V
- · Input Logic Levels
 - $V_{II} = 0.3 V_{CC} Max$
 - $V_{IH} = 0.7 V_{CC} Min$
- Input Current Levels Ii ≤ 5μA at V_{OL}, V_{OH}

Pinouts

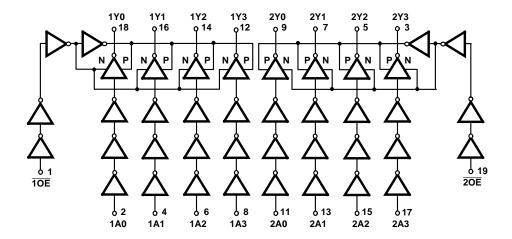
HCS244DTR (SBDIP), CDIP2-T20 TOP VIEW



HCS244KTR (FLATPACK), CDFP4-F20 TOP VIEW



Functional Diagram



TRUTH TABLE

INPUTS		OUTPUT
10E, 20E	A	Y
L	L	L
L	Н	Н
Н	Х	Z

H = High Voltage Level

L = Low Voltage Level

X = Immaterial

Z = High Impedance

Die Characteristics

DIE DIMENSIONS:

 $(2747 \mu m \ x \ 2693 \mu m \ x \ 533 \mu m \ \pm 51.0 \mu m)$

108 x 106 x 21mils ±2mil

METALLIZATION:

Type: Al Si

Thickness: 11.0kÅ ±1kÅ

SUBSTRATE POTENTIAL:

Unbiased Silicon on Sapphire

BACKSIDE FINISH:

Sapphire

PASSIVATION:

Type: Silox (S_iO₂)

Thickness: 13.0kÅ ±2.6kÅ

WORST CASE CURRENT DENSITY:

< 2.0e5 A/cm²

TRANSISTOR COUNT:

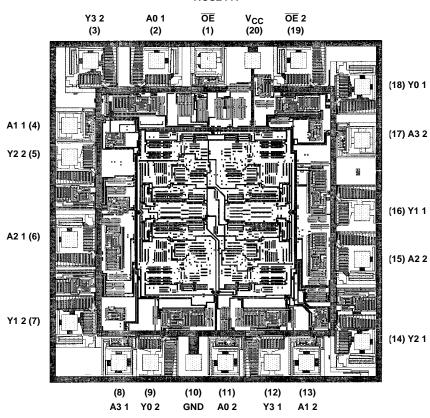
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PROCESS:

CMOS SOS

Metallization Mask Layout

HCS244T



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Sales Office Headquarters

NORTH AMERICA

Intersil Corporation P. O. Box 883, Mail Stop 53-204 Melbourne, FL 32902

TEL: (407) 724-7000 FAX: (407) 724-7240 **EUROPE**

Intersil SA Mercure Center 100, Rue de la Fusee 1130 Brussels, Belgium TEL: (32) 2.724.2111 FAX: (32) 2.724.22.05 **ASIA**

Intersil (Taiwan) Ltd. 7F-6, No. 101 Fu Hsing North Road Taipei, Taiwan Republic of China TEL: (886) 2 2716 9310 FAX: (886) 2 2715 3029

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